MA4X194 (MA194)

Silicon epitaxial planar type

For switching circuits

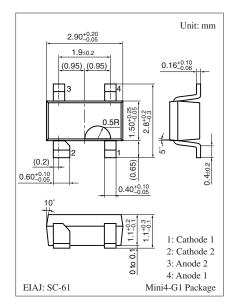
■ Features

- Small terminal capacitance C_t
- Two isolated elements contained in one package, allowing highdensity mounting

■ Absolute Maximum Ratings $T_a = 25$ °C

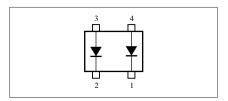
Parameter		Symbol	Rating	Unit
Reverse voltage		V_R	40	V
Repetitive peak reverse voltage		V _{RRM}	40	V
Forward current	Single	$I_{F(AV)}$	100	mA
(Average)	Double		75	
Repetitive peak	Single	I_{FRM}	225	mA
forward current	Double		170	
Non-repetitive peak	Single	I_{FSM}	500	mA
forward surge current *	Double		375	
Junction temperature		T _j	150	°C
Storage temperature		T_{stg}	-55 to +150	°C

Note) *: t = 1 s



Marking Symbol: M1F

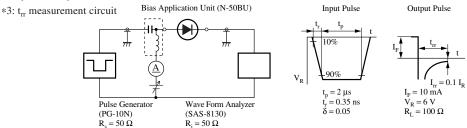
Internal Connection



■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

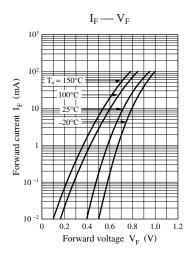
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_F = 100 \text{ mA}$		0.98	1.20	V
Reverse current	I_{R1}	$V_R = 40 \text{ V}$			10	nA
	I_{R2}	$V_R = 35 \text{ V}, T_a = 150^{\circ}\text{C}$			10	μΑ
Terminal capacitance	C _t	$V_R = 6 \text{ V}, f = 1 \text{ MHz}$		1.0	2.0	pF
Forward dynamic resistance	$r_{\rm f}$ *1	$I_F = 3 \text{ mA}, f = 30 \text{ MHz}$		1.7	2.5	Ω
	r _f *2	$I_F = 3 \text{ mA}, f = 30 \text{ MHz}$			3.6	
Reverse recovery time *3	t _{rr}	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			100	ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

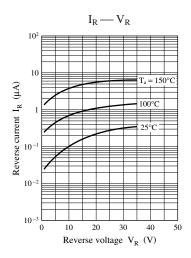
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. Absolute frequency of input and output is 10 MHz.
 - 3. *1: r_f measuring instrument: Nihon Koshuha Model TDC-121A
 - *2: r_f measuring instrument: YHP 4191A RF IMPEDANCE ANALYZER

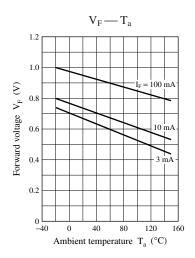


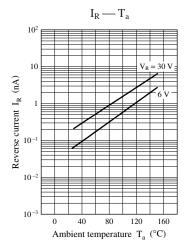
Note) The part number in the parenthesis shows conventional part number.

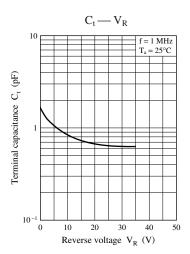
Panasonic











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